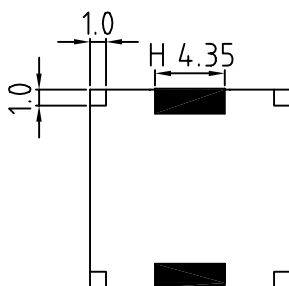
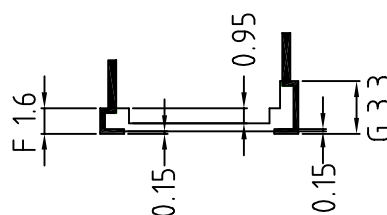
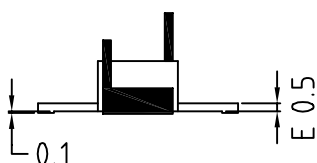
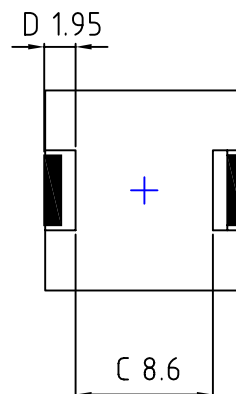
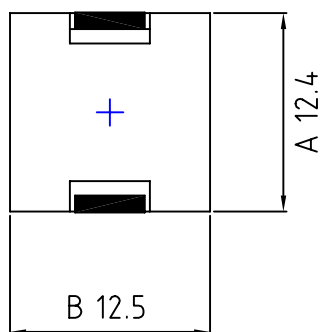




TPI NO.: SMDB0003



FOR CPU POWER INDUCTOR

DATE	REVISED STORY	MODEL : SMD BASE - 3 (TPI NO.: SMDB0003)		
6/01'02	RELEASED THE NEW DRAWING SPEC.	BOBBIN MATERIAL : LCP UL94V-0		
		PIN MATERIAL : PHOSPHORUS BRONZE (TIN PLATED)		
		CLAMP MATERIAL : PHOSPHORUS BRONZE (0.3t)		
		DATE : June 01,2002	REV.: A	TOLERANCE : .XXX±0.08 .XX ±0.1 .X ±0.2